



信昌電子陶瓷股份有限公司  
Prosperity Dielectrics Co., Ltd.

No.220-1, Sec. 2, Nanshan Rd., Lujhu, Taoyuan 33860, Taiwan, R.O.C.  
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Messrs. : \_\_\_\_\_

Date : \_\_\_\_\_

# APPROVAL SHEET

Product Name : Safety Certified Multilayer Ceramic Chip Capacitors

Part No. : FK / FH Series

Description : X1/Y2 & X2 Class, Size 1808~2220, C0G/X7R, 250VAC & UL E231248 Certified, Size 1206, X7R, 2.5KVDC

PREPARED BY	APPROVED BY

信昌電子陶瓷股份有限公司

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# SPECIFICATION

FOR

**Product Name** : Safety Certified Multilayer Ceramic Chip Capacitors  
**Part No.** : FK / FH Series  
**Description** : X1/Y2 & X2 Class, Size 1808~2220, C0G/X7R, 250VAC & UL E231248 Certified, Size 1206, X7R, 2.5KVDC

<b>SPEC. No.</b> :	<u>FKFH-000-001-02</u>
<b>DATE</b> :	

DRAWN BY	CHECEKED BY	APPROVED BY
<b>Yvens Chou</b>	<b>Yvens Chou</b>	<b>Ryan Chen</b>



## 1. INTRODUCTION

PROSPERITY's SAFETY CERTIFIED CAPACITORS are designed for surge or lightning immunity in modem facsimile and other equipments. The capacitors of series FK are class X1/Y2 compliant respectively.

The green type capacitors in FK series are manufactured by using environmentally friendly materials without lead or cadmium.

The terminations are composed of plated nickel and pure tin to feature the superior leaching resistance during soldering.

## 2. FEATURES

- High reliability and stability.
- Small size and high capacitance.
- RoHS compliant.
- Safety standard approval by :  
[EN 132400 : 1994+A2+A3+A4](#)  
[EN 60384-14 : 2013](#)  
[IEC 60384-14 : 2013](#)  
[UL 60384-14 \(Ed 2.0\)](#)  
[UL 62368-1 \(2nd Edition\)](#)
- Certificate number :  
 R 50041666 & R 50359148 by TUV.  
 E346791 (FOWX2/8) by UL, E231248 by UL.
- HALOGEN compliant.



## 3. APPLICATIONS

- Modem.
- Facsimile.
- Telephone.
- Other electronic equipment for lightning or surge protection and isolation.

## 4. HOW TO ORDER

<u>FK</u>	<u>08</u>	<u>N</u>	<u>100</u>	<u>J</u>	<u>502</u>	<u>E</u>	<u>F</u>	<u>G</u>
PDC Family	Size	Dielectric	Capacitance	Tolerance	Rated Voltage	Packaging	Thickness	Control Code
Table1	Table2	Table3	Table4	Table5	Table6	Table7	Table8	Table9

※ Reference document with No.11 reference table detail.

## 5. EXTERNAL DIMENSIONS

Size Inch (mm)	L (mm)	W (mm)	Code / T (mm)	M <sub>B</sub> (mm)	
1206(3216)	3.30±0.30	1.60±0.20	See No.11 Reference Table 8	0.50±0.25	
1808(4520)	4.50+0.5/-0.3	2.00±0.25		0.75±0.35	
1812(4532)	4.50+0.5/-0.3	3.20±0.40		0.75±0.35	
2211(5728)	5.70±0.40	2.80±0.30		0.85±0.35	
2220(5750)	5.70±0.40	5.00±0.40		0.85±0.35	

Fig.5-1 The outline of MLCC

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<http://www.pdc.com.tw>

SPEC. No. : **FKFH-000-001-02**



## 6. GENERAL ELECTRICAL DATA

Dielectric	C0G		X7R							
Size	1808, 1812, 2211		1808, 1812, 2211, 2220	1206						
Rated voltage	250VAC			2.5KVDC						
Capacitance range	X1/Y2 Class (Impulse 6KV) : 4pF ~ 100pF X1/Y2 Class (Impulse 5KV) : 3pF ~ 720pF X2 Class : 3pF ~ 1000pF		X1/Y2 Class : 100pF ~ 4700pF X2 Class : 150pF ~ 22000pF	100pF ~ 1000pF						
Capacitance tolerance	<table border="1"> <thead> <tr> <th>Cap. Rang</th> <th>Tolerance Spec.</th> </tr> </thead> <tbody> <tr> <td>Cap.&lt;10pF</td> <td>D (±0.5pF)</td> </tr> <tr> <td>10pF≤Cap.</td> <td>F (±1%), G (±2%), J (±5%), K (±10%), M (±20%)</td> </tr> </tbody> </table>		Cap. Rang	Tolerance Spec.	Cap.<10pF	D (±0.5pF)	10pF≤Cap.	F (±1%), G (±2%), J (±5%), K (±10%), M (±20%)	J (±5%) K (±10%) M (±20%)	
Cap. Rang	Tolerance Spec.									
Cap.<10pF	D (±0.5pF)									
10pF≤Cap.	F (±1%), G (±2%), J (±5%), K (±10%), M (±20%)									
Tan δ	<table border="1"> <thead> <tr> <th>Cap. Rang</th> <th>Q Spec.</th> </tr> </thead> <tbody> <tr> <td>Cap.&lt;30pF</td> <td>Q≥400+20C</td> </tr> <tr> <td>Cap.≥30pF</td> <td>Q≥1000</td> </tr> </tbody> </table>		Cap. Rang	Q Spec.	Cap.<30pF	Q≥400+20C	Cap.≥30pF	Q≥1000	≤2.5%	
Cap. Rang	Q Spec.									
Cap.<30pF	Q≥400+20C									
Cap.≥30pF	Q≥1000									
Capacitance & Tan δ Test condition	Measured at the condition of 30~70% related humidity									
	for 25°C at ambient temperature		Preconditioning for Class II MLCC : Perform a heat treatment at 150±10°C for 1 hour, then leave in ambient condition for 24±2 hours before measurement							
	<table border="1"> <thead> <tr> <th>Cap. Rang</th> <th>Test Condition</th> </tr> </thead> <tbody> <tr> <td>Cap.≤1000pF</td> <td>1.0±0.2Vrms, 1.0MHz±10%</td> </tr> <tr> <td>Cap.&gt;1000pF</td> <td>1.0±0.2Vrms, 1.0KHz±10%</td> </tr> </tbody> </table>		Cap. Rang	Test Condition	Cap.≤1000pF	1.0±0.2Vrms, 1.0MHz±10%	Cap.>1000pF	1.0±0.2Vrms, 1.0KHz±10%	1.0±0.2Vrms, 1.0KHz±10%, at 25°C ambient temperature	
Cap. Rang	Test Condition									
Cap.≤1000pF	1.0±0.2Vrms, 1.0MHz±10%									
Cap.>1000pF	1.0±0.2Vrms, 1.0KHz±10%									
Insulation resistance	≥100GΩ or RxC≥1000Ω-F, whichever is smaller		≥10GΩ or RxC≥500Ω-F, whichever is smaller							
Operating temperature	-55°C to +125°C									
Temperature coefficient	±30ppm /°C		±15%							
Termination	Cu or Ag/Ni/Sn (lead-free termination)									

## 7. CAPACITANCE RANGE

Class		X1/Y2 (FK series)								X2 (FH series)						
Rated voltage		250Vac														2.5KVdc
Certificated		TUV IEC60384-14 / UL 60384														UL 62368
Dielectric		C0G				X7R				C0G		X7R			X7R	
Cap.(pF)	EIA Size	1808	1812	2211	2211	1808	1812	2211	2220	1808	1812	1808	1812	2220	1206	
	Impulse	5KV			6KV	5KV				2.5KV						---
3.0	3R0	D								D						
3.3	3R3	D								D						
4.0	4R0	D		F	F					D						
4.7	4R7	D		F	F					D						
5.0	5R0	D		F	F					D						
5.6	5R6	D		F	F					D						
6.8	6R8	D		F	F					D						
8.2	8R2	D		F	F					D						
9.0	9R0	D		F	F					D						
10	100	D	C	F	F					D	C					
12	120	D	C	F	F					D	C					
15	150	D	C	F	F					D	C					
18	180	D	C	F	F					D	C					
22	220	D	C	F	F					D	C					
27	270	D	C	F	F					D	C					
33	330	D	C	F	F					D	C					
39	390	E	C	F	F					E	C					
47	470	E	C	F	F					E	C					
56	560	E	C	F	F					E	C					
68	680	E	C	F	G					E	C					
82	820	E	C	F	G					E	C					
100	101	F	C	F	H	E				F	C				C	
120	121	F	C	G		E				F	C				C	
130	131	F	C	G		E		E		F	C				C	
150	151	F	C	G		E	E	E		F	C	E			C	
160	161	F	C	G		E	E	E	F	F	C	E			C	
180	181	F	C	G		E	E	E	F	F	C	E			C	
220	221	F	F	G		E	E	E	F	F	C	E			C	
270	271	F	F	G		F	E	E	F	F	C	E	E		C	
300	301		F	G		F	E	E	F	F	C	E	E		C	
330	331		F	G		F	E	E	F	F	C	E	E		C	
390	391		F	G		F	E	E	F	F	C	E	E		C	
470	471		F	G		F	E	F	F	F	C	E	E		C	
560	561			G		F	E	F	F	F	C	E	E		C	
680	681			G		F	F	F	F	F	F	E	E		C	
720	721			G		F	F	F	F	F	F	E	E		C	
820	821					F	F	F	F	F	F	E	E		C	
1000	102					F	G	G	F	F	F	F	E		C	
1200	122							G	G			F	E			
1500	152							G	G			F	F			
1800	182							G	G			F	F			
2200	222							G	G			F	G			
2700	272								G				G			
3300	332								G				G			
3900	392								G				G			
4700	472								G				G			
5600	562												G			
6800	682															
8200	822															
10000	103													G		
12000	123													G		
15000	153													G		
18000	183													G		
22000	223													H		

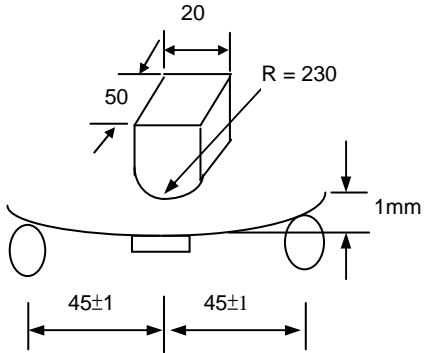
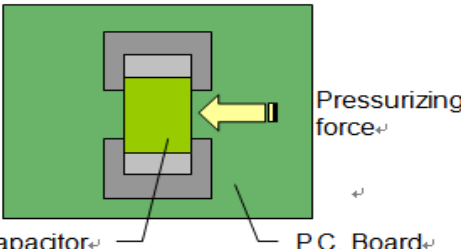
## 8. RELIABILITY TEST CONDITIONS AND REQUIREMENTS

No.	Item	Standard Methods	Test Condition	Requirements														
1.	Visual examination and Dimensions	IEC 60384-1 4.1	---	* No remarkable defect. * Dimensions to confirm to individual specification sheet.														
2.	Capacitance	IEC 60384-1 4.2.2	* Class I : (C0G) Cap.≤1000pF, 1.0±0.2Vrms, 1MHz±10%. Cap.>1000pF, 1.0±0.2Vrms, 1KHz±10%.	* Capacitance is within specified tolerance. * C <sub>R</sub> means rated capacitance for conform to the E6 series of preferred values given in IEC 60063.														
3.	Q/D.F. (Dissipation Factor)	IEC 60384-1 4.2.3	* Class II : (X7R) 1.0±0.2Vrms, 1KHz±10%.	<table border="1"> <thead> <tr> <th>Dielectric</th> <th>Q/D.F.</th> <th>Remark</th> </tr> </thead> <tbody> <tr> <td rowspan="2">Class I (C0G)</td> <td>Q≥1000</td> <td>Cap.≥30pF</td> </tr> <tr> <td>Q≥400+20C</td> <td>Cap.&lt;30pF</td> </tr> <tr> <td>Class II (X7R)</td> <td>D.F.≤2.5%</td> <td></td> </tr> </tbody> </table>	Dielectric	Q/D.F.	Remark	Class I (C0G)	Q≥1000	Cap.≥30pF	Q≥400+20C	Cap.<30pF	Class II (X7R)	D.F.≤2.5%				
Dielectric	Q/D.F.	Remark																
Class I (C0G)	Q≥1000	Cap.≥30pF																
	Q≥400+20C	Cap.<30pF																
Class II (X7R)	D.F.≤2.5%																	
4.	Temperature Coefficient	IEC 60384-21/22 4.6	* With no electrical load.	<table border="1"> <thead> <tr> <th>T.C.</th> <th>Operating Temp.</th> <th>T.C.</th> <th>Capacitance Change</th> </tr> </thead> <tbody> <tr> <td>C0G</td> <td>-55~125°C at 25°C</td> <td>C0G</td> <td>±30ppm/°C</td> </tr> <tr> <td>X7R</td> <td>-55~125°C at 25°C</td> <td>X7R</td> <td>±15%</td> </tr> </tbody> </table>	T.C.	Operating Temp.	T.C.	Capacitance Change	C0G	-55~125°C at 25°C	C0G	±30ppm/°C	X7R	-55~125°C at 25°C	X7R	±15%		
T.C.	Operating Temp.	T.C.	Capacitance Change															
C0G	-55~125°C at 25°C	C0G	±30ppm/°C															
X7R	-55~125°C at 25°C	X7R	±15%															
5.	Voltage proof (Dielectric Strength)	IEC 60384-14 4.2.1	* To apply voltage : X Capacitor : 1075Vdc (4.3U <sub>R</sub> ). Y Capacitor : 1500Vac. * Duration : 60 sec. * The charge current shall not exceed 0.05A. * The voltage shall be raised from the near zero to the test voltage a rate not exceeding 150V(r.m.s.)/sec. * For FH06X series : 2.5KVdc.	* No evidence of damage or flash over during test.														
6.	Insulation Resistance	IEC 60384-21/22 4.5.3	<table border="1"> <thead> <tr> <th>Rated Vol.(V)</th> <th>Apply Voltage</th> <th>Charge Current</th> <th>Charge Time</th> </tr> </thead> <tbody> <tr> <td>&gt;500</td> <td>500Vdc</td> <td>≤50mA</td> <td>60 sec.</td> </tr> </tbody> </table>	Rated Vol.(V)	Apply Voltage	Charge Current	Charge Time	>500	500Vdc	≤50mA	60 sec.	<table border="1"> <thead> <tr> <th>Dielectric</th> <th>Requirements</th> </tr> </thead> <tbody> <tr> <td>Class I (C0G)</td> <td>≥100GΩ or RxC≥1000Ω-F, whichever is smaller</td> </tr> <tr> <td>Class II (X7R)</td> <td>≥10GΩ or RxC≥500Ω-F, whichever is smaller</td> </tr> </tbody> </table>	Dielectric	Requirements	Class I (C0G)	≥100GΩ or RxC≥1000Ω-F, whichever is smaller	Class II (X7R)	≥10GΩ or RxC≥500Ω-F, whichever is smaller
Rated Vol.(V)	Apply Voltage	Charge Current	Charge Time															
>500	500Vdc	≤50mA	60 sec.															
Dielectric	Requirements																	
Class I (C0G)	≥100GΩ or RxC≥1000Ω-F, whichever is smaller																	
Class II (X7R)	≥10GΩ or RxC≥500Ω-F, whichever is smaller																	
7.	Solderability	IEC 60384-21/22 4.10	* Solder temperature : 235±5°C (0201~1210). * Solder temperature : 245±5°C (1808~2225). * Dipping time : 2±0.5 sec.	* 75% min. coverage of all metalized area.														
8.	Resistance to Soldering Heat	IEC 60384-14 4.4 IEC 60384-21/22 4.9	* Solder temperature : 260±5°C. * Dipping time : 10±1 sec. * Preheating : 120 to 150°C for 1 minute before immerse the capacitor in a eutectic solder. * Measurement to be made after keeping at room temperature for 24±2 hrs (Class I).	<table border="1"> <thead> <tr> <th>Dielectric</th> <th>I.R.</th> <th>Cap. Change</th> <th>Q/D.F.</th> </tr> </thead> <tbody> <tr> <td>Class I (C0G)</td> <td>≥1GΩ</td> <td>Within ±2.5% or ±0.25pF, whichever is larger</td> <td rowspan="2">≤100% of initial requirement</td> </tr> <tr> <td>Class II (X7R)</td> <td>≥1GΩ</td> <td>Within ±7.5%</td> </tr> </tbody> </table>	Dielectric	I.R.	Cap. Change	Q/D.F.	Class I (C0G)	≥1GΩ	Within ±2.5% or ±0.25pF, whichever is larger	≤100% of initial requirement	Class II (X7R)	≥1GΩ	Within ±7.5%			
Dielectric	I.R.	Cap. Change	Q/D.F.															
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Class II (X7R)	≥1GΩ	Within ±7.5%																

## 8. RELIABILITY TEST CONDITIONS AND REQUIREMENTS

No.	Item	Standard Methods	Test Condition	Requirements															
9.	Temperature Cycle	IEC 60384-21/22 4.11	* Conduct the five cycles according to the temperatures and time.	<table border="1"> <thead> <tr> <th>Dielectric</th> <th>I.R.</th> <th>Cap. Change</th> <th>Q/D.F.</th> </tr> </thead> <tbody> <tr> <td>Class I (COG)</td> <td rowspan="2">To meet initial requirement</td> <td>Within <math>\pm 2.5\%</math> or <math>\pm 0.25\text{pF}</math>, whichever is larger</td> <td><math>\leq 1.0(Q) \times</math> initial requirement</td> </tr> <tr> <td>Class II (X7R)</td> <td>Within <math>\pm 7.5\%</math></td> <td><math>\leq 1.5(D.F.) \times</math> initial requirement</td> </tr> </tbody> </table>	Dielectric	I.R.	Cap. Change	Q/D.F.	Class I (COG)	To meet initial requirement	Within $\pm 2.5\%$ or $\pm 0.25\text{pF}$ , whichever is larger	$\leq 1.0(Q) \times$ initial requirement	Class II (X7R)	Within $\pm 7.5\%$	$\leq 1.5(D.F.) \times$ initial requirement				
			Dielectric		I.R.	Cap. Change	Q/D.F.												
Class I (COG)	To meet initial requirement	Within $\pm 2.5\%$ or $\pm 0.25\text{pF}$ , whichever is larger	$\leq 1.0(Q) \times$ initial requirement																
Class II (X7R)		Within $\pm 7.5\%$	$\leq 1.5(D.F.) \times$ initial requirement																
			<table border="1"> <thead> <tr> <th>Step</th> <th>Temp.(°C)</th> <th>Time(min.)</th> </tr> </thead> <tbody> <tr> <td>1</td> <td>Min. operating temp. +0/-3</td> <td>30<math>\pm</math>3</td> </tr> <tr> <td>2</td> <td>Room temp.</td> <td>2~3</td> </tr> <tr> <td>3</td> <td>Max. operating temp. +3/-0</td> <td>30<math>\pm</math>3</td> </tr> <tr> <td>4</td> <td>Room temp.</td> <td>2~3</td> </tr> </tbody> </table>	Step	Temp.(°C)	Time(min.)	1	Min. operating temp. +0/-3	30 $\pm$ 3	2	Room temp.	2~3	3	Max. operating temp. +3/-0	30 $\pm$ 3	4	Room temp.	2~3	
Step	Temp.(°C)	Time(min.)																	
1	Min. operating temp. +0/-3	30 $\pm$ 3																	
2	Room temp.	2~3																	
3	Max. operating temp. +3/-0	30 $\pm$ 3																	
4	Room temp.	2~3																	
			* Measurement to be made after keeping at room temperature for 24c hrs (Class I)																
10.	Humidity (Damp Heat) Steady State	IEC 60384-14 4.12	* Test temp. : 40 $\pm$ 2°C.	<table border="1"> <thead> <tr> <th>Dielectric</th> <th>I.R.</th> <th>Cap. Change</th> <th>Q/D.F.</th> </tr> </thead> <tbody> <tr> <td>Class I (COG)</td> <td rowspan="2"><math>\geq 1\text{G}\Omega</math> or <math>RxC \geq 25\Omega\text{-F}</math>, whichever is smaller</td> <td>Within <math>\pm 3.0\%</math> or <math>\pm 2\text{pF}</math>, whichever is larger</td> <td><math>\leq 0.25\%</math></td> </tr> <tr> <td>Class II (X7R)</td> <td>Within <math>\pm 15\%</math></td> <td><math>\leq 2.0(D.F.) \times</math> initial requirement</td> </tr> </tbody> </table>	Dielectric	I.R.	Cap. Change	Q/D.F.	Class I (COG)	$\geq 1\text{G}\Omega$ or $RxC \geq 25\Omega\text{-F}$ , whichever is smaller	Within $\pm 3.0\%$ or $\pm 2\text{pF}$ , whichever is larger	$\leq 0.25\%$	Class II (X7R)	Within $\pm 15\%$	$\leq 2.0(D.F.) \times$ initial requirement				
			Dielectric		I.R.	Cap. Change	Q/D.F.												
Class I (COG)	$\geq 1\text{G}\Omega$ or $RxC \geq 25\Omega\text{-F}$ , whichever is smaller	Within $\pm 3.0\%$ or $\pm 2\text{pF}$ , whichever is larger	$\leq 0.25\%$																
Class II (X7R)		Within $\pm 15\%$	$\leq 2.0(D.F.) \times$ initial requirement																
			* Humidity : 90~95% RH.																
			* Test time : 500 +24/-0hrs.																
			* Applied voltage : 250Vac.																
			* Measurement to be made after keeping at room temp. for 24 $\pm$ 2 hrs (Class I) and 48 $\pm$ 4 hrs (Class II).																
			* No remarkable damage.																
11.	Passive Flammability	IEC 60384-14 4.17 IEC 60384-1 4.38	* Volume sample : 21.56 mm <sup>3</sup> .	* Capacitor didn't burn at all. (FH06X series not include)															
			* Flame exposure time : 5 sec. Max.																
			* Category of flammability : C.																
12.	Active Flammability	IEC 60384-14 4.17 IEC 60384-1 4.38	* The capacitors applied UR (250Vac). Then each sample shall be subjected to 20 discharges from a tank capacitor, charge to a voltage that, when discharged, places Ui 2500V for X2, Ui 5000V for X1Y2 across the capacitor under test. The interval between successive discharges shall be 5 sec.	* The cheese cloth shall not burn with a flame. (FH06X series not include)															
13.	High Temperature Load (Endurance)	IEC 60384-14 4.14	* Impulse Voltage : Each individual capacitor shall be subjected to a Vp = 5.0KV (X1Y2 Class Impulse 5KV) & Vp = 6.0KV (X1Y2 Class Impulse 6KV) impulse for three times before applied to endurance test.	* Appearance : No mechanical damage.															
			* Test temp. : 125 $\pm$ 3°C.	* Cap. change : COG within $\pm 5\%$ or $\pm 0.5\text{pF}$ , whichever is larger. X7R within $\pm 20\%$ .															
			* Test time : 1000 +48/-0 hrs.	* D.F. value : COG $\leq 0.25\%$ . X7R $\leq 5.0\%$ .															
			* Applied voltage : X capacitor : 1.25UR (312.5Vac). Y capacitor : 1.70UR (425Vac).	* I.R. $\geq 1\text{G}\Omega$ .															
			Once every hour the voltage shall be increased to 1000Vrms for 0.1 sec.	* Dielectric strength satisfies the specified initial value.															
			* Measurement to be made after keeping at room temp. for 24 $\pm$ 2 hrs (Class I) and 48 $\pm$ 4 hrs (Class II).																
			For FH06X series : * Test temp. : 125 $\pm$ 3°C.																
			* To apply voltage : 2.5KVdc.																
			* Test time : 1000 +24/-0 hrs.																
			* Measurement to be made after keeping at room temp. for 48 $\pm$ 4 hrs.																

## 8. RELIABILITY TEST CONDITIONS AND REQUIREMENTS

No.	Item	Standard Methods	Test Condition	Requirements						
14.	Resistance to Flexure of Substrate	IEC 60384-21/22 4.8	<p>* Capacitors mounted on a substrate. The board shall be bent 1mm with a rate of 1mm/sec.</p> 	<p>* No remarkable damage.</p> <table border="1"> <thead> <tr> <th>Dielectric</th> <th>Cap. Change</th> </tr> </thead> <tbody> <tr> <td>Class I (C0G)</td> <td>Within ±3.0% or ±2pF, whichever is larger</td> </tr> <tr> <td>Class II (X7R)</td> <td>Within ±12.5%</td> </tr> </tbody> </table> <p>(This capacitance change means the change of capacitance under specified flexure of substrate from the capacitance measured before the test)</p>	Dielectric	Cap. Change	Class I (C0G)	Within ±3.0% or ±2pF, whichever is larger	Class II (X7R)	Within ±12.5%
Dielectric	Cap. Change									
Class I (C0G)	Within ±3.0% or ±2pF, whichever is larger									
Class II (X7R)	Within ±12.5%									
15.	Adhesive Strength of Termination	IEC 60384-21/22 4.15 IEC 60384-1 4.13	<p>* Capacitors mounted on a substrate. A force of 10N applied perpendicular to the place of substrate and parallel the line joining the center of terminations for 10±1 sec.</p> 	<p>* No remarkable damage or removal of the terminations.</p>						
16.	Vibration	IEC 60384-1 4.17	<p>* Reflow solder the capacitors on P. C. Board before test.</p> <p>* Vibration frequency : 10~55 Hz/min.</p> <p>* Total amplitude : 1.5mm.</p> <p>* Repeat the conditions for 2 hours each in 3 perpendicular directions.</p>	<p>* No remarkable damage.</p> <p>* Cap. change and Q/D.F. : To meet initial spec.</p>						
17.	Impulse Voltage	IEC 60384-14 4.13	<p>* X1 : 4.0KV, X2 : 2.5KV.</p> <p>* Y2 : 5.0KV.</p> <p>* Number of impulse : 24 max.</p>	<p>* There shall be no permanent breakdown or flashover.</p> <p>(FH06X series not include)</p>						



## 9. PACKAGE DIMENSION AND QUANTITY

Size	Thickness (mm)	Plastic tape	
		7" reel	13" reel
1206(3216)	1.25±0.10	3k	10k
1808(4520)	1.25±0.10	2k	10k
	1.60±0.20	2k	8k
	2.00±0.20	1k	6k
1812(4532)	1.25±0.10	1k	-
	1.60±0.20	1k	-
	2.00±0.20	1k	-
	2.50±0.30	0.5k	3k
2211(5728)	1.60±0.20	1k	-
	2.00±0.20	1k	-
	2.50±0.30	0.5k	-
	2.80±0.30	0.5k	-
2220(5750)	2.00±0.20	1k	-
	2.50±0.30	0.5k	2k

### REEL DIMENSIONS

Size	1206, 1808, 1812, 2211, 2220
Reel size	7"
C	13.0 +0.5/-0.2
W <sub>1</sub>	12.4 +2.0/-0
A	178.0±0.1
N	80.0±1.0

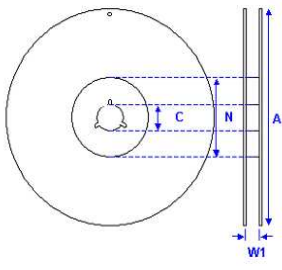
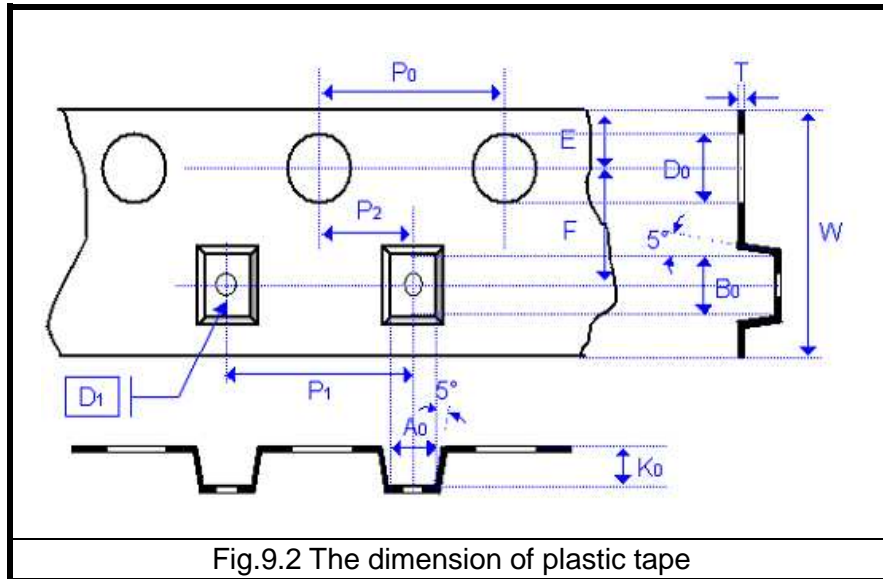


Fig.9.1 The dimension of plastic tape

### 9.1. EMBOSSED TAPE DIMENSIONS



Size	1206	1808		1812		2211		2220		
Chip Thickness	1.25±0.10	1.25±0.10	1.40±0.15	2.00±0.20	1.60±0.20	2.00±0.20	2.50±0.30	2.80±0.30	2.00±0.20	2.50±0.30
A <sub>0</sub>	<2.00	<2.50	<2.50	<2.50	<3.90	<3.90	<3.30	<3.30	<5.80	<5.80
B <sub>0</sub>	<3.60	<5.30	<5.30	<5.30	<5.30	<5.30	<6.50	<6.50	<6.50	<6.50
T	0.23±0.05	0.25±0.05	0.25±0.05	0.25±0.05	0.25±0.05	0.25±0.05	0.30±0.10	0.30±0.10	0.30±0.10	0.30±0.10
K <sub>0</sub>	<2.50	<2.50	<2.50	<2.50	<2.50	<3.00	<2.50	<3.10	<2.50	<3.10
W	8.00±0.10	12.0±0.20	12.0±0.20	12.0±0.20	12.0±0.20	12.0±0.20	12.0±0.20	12.0±0.20	12.0±0.20	12.0±0.20
P <sub>0</sub>	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10
10xP <sub>0</sub>	40.00±0.20	40.0±0.20	40.0±0.20	40.0±0.20	40.00±0.20	40.00±0.20	40.0±0.20	40.0±0.20	40.00±0.20	40.00±0.20
P <sub>1</sub>	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	8.00±0.10	8.00±0.10	8.00±0.10	8.00±0.10	8.00±0.10	8.00±0.10
P <sub>2</sub>	2.00±0.05	2.00±0.05	2.00±0.05	2.00±0.05	2.00±0.05	2.00±0.05	2.00±0.05	2.00±0.05	2.00±0.05	2.00±0.05
D <sub>0</sub>	1.50±0.10/-0	1.50±0.10/-0	1.50±0.10/-0	1.50±0.10/-0	1.50±0.10/-0	1.50±0.10/-0	1.50±0.10/-0	1.50±0.10/-0	1.50±0.10/-0	1.50±0.10/-0
D <sub>1</sub>	1.00±0.10	1.50±0.10	1.50±0.10	1.50±0.10	1.50±0.10	1.50±0.10	1.50±0.10	1.50±0.10	1.50±0.10	1.50±0.10
E	1.75±0.10	1.75±0.10	1.75±0.10	1.75±0.10	1.75±0.10	1.75±0.10	1.75±0.10	1.75±0.10	1.75±0.10	1.75±0.10
F	3.50±0.05	5.50±0.05	5.50±0.05	5.50±0.05	5.50±0.05	5.50±0.05	5.50±0.05	5.50±0.05	5.50±0.05	5.50±0.05
Unit :	mm	mm	mm	mm	mm	mm	mm	mm	mm	mm

Prosperity Dielectrics Co., Ltd.

No.220-1, Sec. 2, Nanshan Rd., Lujhu, Taoyuan 33860, Taiwan, R.O.C.

<http://www.pdc.com.tw>

SPEC. No. : FKFH-000-001-02

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## 10. APPLICATION NOTES

### STORAGE

To prevent the damage of solderability of terminations, the following storage conditions are recommended :

Indoors under 5 ~ 40°C and 20% ~ 70% RH.

No harmful gases containing sulfuric acid, ammonia, hydrogen sulfide or chlorine.

Packaging should not be opened until the capacitors are required for use. If opened, the pack should be re-sealed as soon as is practicable. Taped product should be stored out of direct sunlight, which might promote deterioration in tape or adhesion performance. The product is recommended to be used within 12 months after shipment and checked the solderability before use.

### HANDLING

Chip capacitors are dense, hard, brittle, and abrasive materials. They are liable to suffer mechanical damage, in the form of cracks or chips. Chip Capacitors should be handled with care to avoid contamination or damage. To use vacuum or plastic tweezers to pick up or plastic tweezers is recommended for manual placement. Tape and reeled packages are suitable for automatic pick and placement machine.

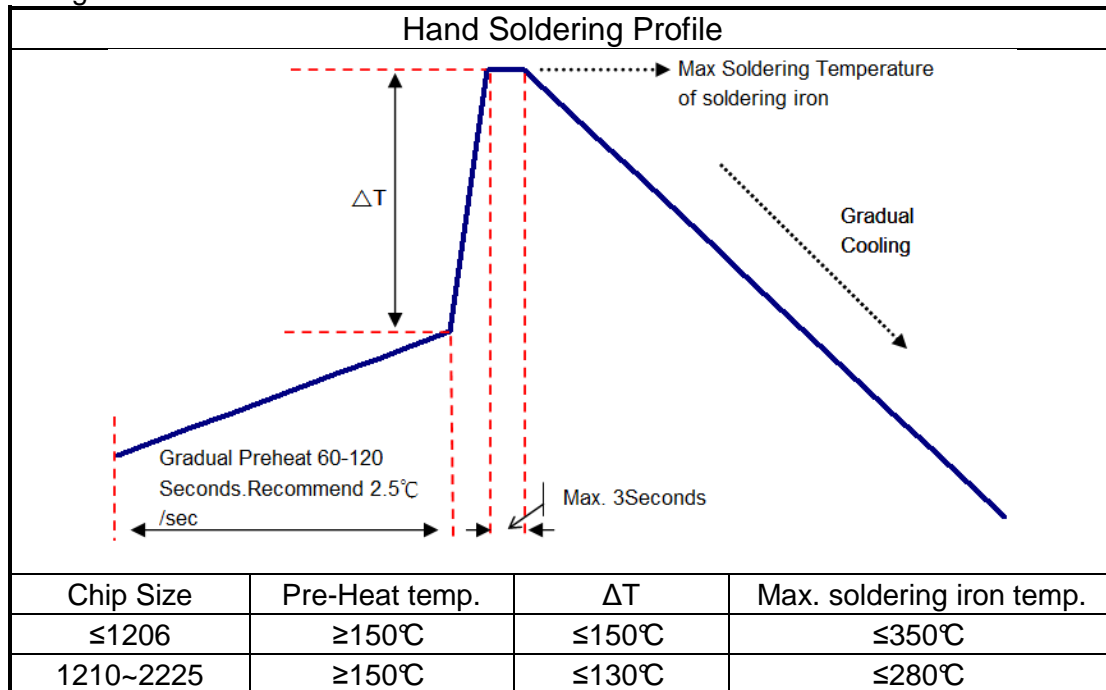
### PREHEAT

In order to minimize the risk of thermal shock during soldering, a carefully controlled preheat is required. The rate of preheat should not exceed 3°C per second.

### SOLDERING

Use middy activated rosin RA and RMA fluxes do not use activated flux. The amount of solder in each solder joint should be controlled to prevent the damage of chip capacitors caused by the stress between solder, chips, and substrate.

a.) Hand soldering :



\* Soldering iron tip diameter  $\leq 1.0$  mm and wattage max. 20W.

\* The Capacitors shall be pre-heated and that the temperature gradient between the devices and the tip of the soldering iron.

\* The required amount of solder shall be melted on the soldering tip.

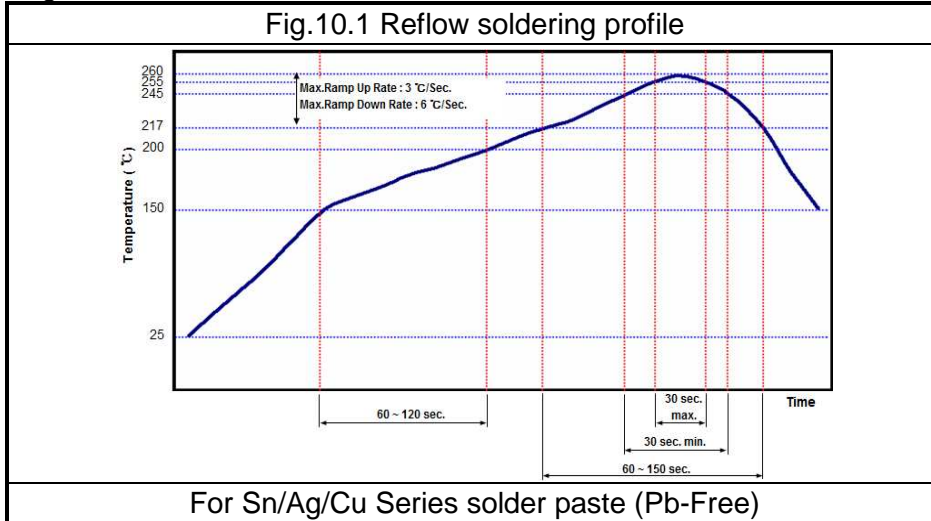
\* The tip of iron should not contact the ceramic body directly.

\* The Capacitors shall be cooled gradually at room temperature after soldering.

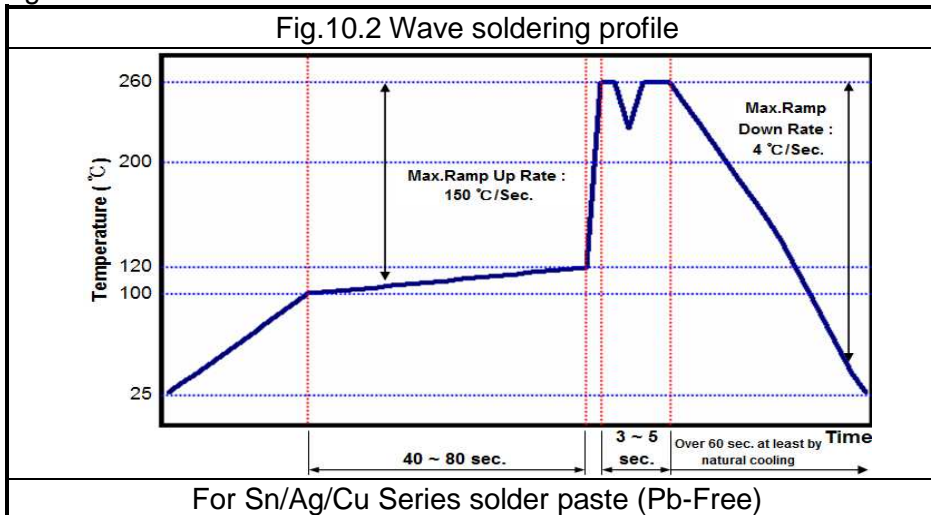
\* Forced air cooling is not allowed.

## 10. APPLICATION NOTES

b.) Reflow soldering :



c.) Wave soldering :



Soldering conditions :

Class I :

Size Inch (mm)	Temper. Cher.	Capacitance	Condition	
			Wave	Reflow
≤0402(1005)	Class I - C0G	All	X	O
0603(1608)	Class I - C0G	All	O	O
0805(2012)	Class I - C0G	All	O	O
1206(3216)	Class I - C0G	All	O	O
≥1210(3225)	Class I - C0G	All	X	O

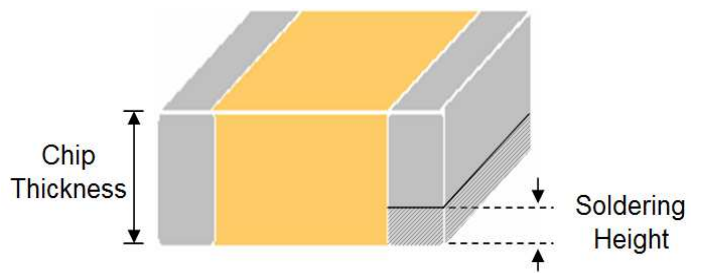
Class II :

Size Inch (mm)	Temper. Cher.	Capacitance	Condition	
			Wave	Reflow
≤0402(1005)	Class II - X7R	All	X	O
0603 (1608)	Class II - X7R	Cap. <2.2μF	O	O
		Cap. ≥2.2μF	X	O
0805 (2012)	Class II - X7R	Cap. <4.7μF	O	O
		Cap. ≥4.7μF	X	O
1206 (3216)	Class II - X7R	Cap. <4.7μF	O	O
		Cap. ≥4.7μF	X	O
≥1210 (3225)	Class II - X7R	All	X	O

## 10. APPLICATION NOTES

Soldering height :

The solder climbing minimum height is suggesting to 25% of chip thickness or 500um whichever is less.  
(Reference from IPC-610E)



## COOLING

After soldering, cool the chips and the substrate gradually to room temperature. Natural cooling in air is recommended to minimize stress in the solder joint.

## CLEANING

All flux residues must be removed by using suitable electronic-grade vapor-cleaning solvents to eliminate contamination that could cause electrolytic surface corrosion. Good results can be obtained by using ultrasonic cleaning of the solvent. The choice of the proper system is depends upon many factors such as component mix, flux, and solder paste and assembly method. The ability of the cleaning system to remove flux residues and contamination from under the chips is very important.

## 11. REFERENCE TABLE

Table 1		PDC family	
Code	Description		
FK	Safety X1 & Y2 series		
FH	Safety X2 series		

Table 2		Size			
Code	Description	Code	Description	Code	Description
06	1206 (3216)	12	1812 (4532)	20	2220 (5750)
08	1808 (4520)	21	2211 (5728)		

Table 3		Dielectric Material Characteristics	
Code	Description	Code	Description
N	C0G	X	X7R

Table 4		Table 4 Capacitance Rule Code	
Code	Description	Code	Description
R47	0.47pF	102	$102=10 \times 10^2=1000\text{pF}$
0R5	0.5pF	104	$104=10 \times 10^4=100\text{nF}$
100	$100=10 \times 10^0=10\text{pF}$	106	$106=10 \times 10^6=10\mu\text{F}$

Table 5		Tolerance			
Code	Description	Code	Description	Code	Description
B	$\pm 0.10 \text{ pF}$	F	$\pm 1 \%$	K	$\pm 10 \%$
C	$\pm 0.25 \text{ pF}$	G	$\pm 2 \%$	M	$\pm 20 \%$
D	$\pm 0.50 \text{ pF}$	J	$\pm 5 \%$		

Table 6		Rated voltage			
Code	Description	Code	Description	Code	Description
252	2.5KV	502	5KV	602	6KV

Table 7		Packaging Type	
Code	Description	Code	Description
B	Bulk	T	Tray package
E	Tape and 7" Reel, Embossed Tape	P	Tape and 7" Reel, Paper Tape
K	Tape and 10" Reel, Embossed Tape	D	Tape and 10" Reel, Paper Tape
L	Tape and 13" Reel, Embossed Tape	G	Tape and 13" Reel, Paper Tape

Table 8		Thickness Description			
Code	Description	Code	Description	Code	Description
C	$1.25 \pm 0.10 \text{ mm}$	E	$1.60 \pm 0.20 \text{ mm}$	G	$2.50 \pm 0.30 \text{ mm}$
D	$1.40 \pm 0.15 \text{ mm}$	F	$2.00 \pm 0.20 \text{ mm}$	H	$2.80 \pm 0.30 \text{ mm}$

Table 9		Special Control Code	
Code	Description		
G	RoHS Compliant		